

# MERE 2020

*Hongkong / November 20th-22th, 2020*

## *The 2nd International Conference on Mechanical, Electronic and Robotics Engineering*

2020 the 2nd International Conference on Mechanical, Electronic and Robotics Engineering (MERE 2020) is a forum for presenting excellent results and new challenges facing the field of Mechanical, Electronic and Robotics Engineering. It brings together experts from industry, governments and academia, experienced in engineering, design and research.

### Publication

All accepted papers of MERE 2020 will be published into MERE 2020 conference proceedings, which will be submitted for EI Compendex, Scopus, Thomson Reuters (WoS), Inspec index, et al.

### Call for Paper

- Mechanical Engineering
  - Acoustics and Noise Control
  - Material Science and Processing
  - Aerodynamics
  - Mechanical Design
- Electronics Engineering
  - Circuits and Systems
  - Analog Circuits
  - Digital Circuits
  - Mixed Signal Circuits
- Robotics Science and Engineering
  - Modeling and identification
  - Robot control
  - Mobile robotics
  - Mobile sensor networks

For details about topics, please visit:

<http://mere.org/cfp.html>

### Important Date

- Submission Deadline: July 5th, 2020
- Notification Day: July 30th, 2020
- Registration Deadline: Aug 20th, 2020
- Conference Date: November 20th-22th, 2020

### Submission Method

1. Full Paper(publication and oral presentation)
2. Abstract(oral presentation only)  
Conference Submission System (.pdf)  
<http://confsys.iconf.org/submission/mere2020>

### Contact Us

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